

L Number	Hits	Search Text	DB	Time stamp
-	288	((low adj k adj dielectric low-k-dielectric low-k adj dielectric ((low adj k low-k) adj material)) and (etch\$3 plasma) and (nitrogen N2 "n.sub.2") and (fluorocarbon hydrofluorocarbon C4F6 C5F8 C4F8 CF2H2 CH2F2 "C.sub.4 F.sub.6" "C.sub.5 F.sub.8" "C.sub.4 F.sub.8" "CF.sub.2 H.sub.2" "CH.sub.2 F.sub.2"))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/02/17 13:18
-	18	((low adj k adj dielectric low-k-dielectric low-k adj dielectric ((low adj k low-k) adj material)) and (etch\$3 plasma) and (nitrogen N2 "n.sub.2") and (fluorocarbon hydrofluorocarbon C4F6 C5F8 C4F8 CF2H2 CH2F2 "C.sub.4 F.sub.6" "C.sub.5 F.sub.8" "C.sub.4 F.sub.8" "CF.sub.2 H.sub.2" "CH.sub.2 F.sub.2")) and etch\$3 same (low adj k adj dielectric low-k-dielectric low-k adj dielectric ((low adj k low-k) adj material)) same ((nitrogen N2 "n.sub.2") with (fluorocarbon hydrofluorocarbon C4F6 C5F8 C4F8 CF2H2 CH2F2 "C.sub.4 F.sub.6" "C.sub.5 F.sub.8" "C.sub.4 F.sub.8" "CF.sub.2 H.sub.2" "CH.sub.2 F.sub.2"))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/09/14 16:14
-	71	etch\$3 with (low adj k low-k BCB SiLk) and (oxygen-free oxygen adj free ((O2 "O.sub.2" oxygen) near (without free)))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/02/06 20:10
-	19	etch\$3 with (low adj k low-k BCB SiLk) same (oxygen-free oxygen adj free ((O2 "O.sub.2" oxygen) near (without free)))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/02/06 19:58
-	9	etch\$3 with (low adj k low-k BCB SiLk) with (oxygen-free oxygen adj free ((O2 "O.sub.2" oxygen) near (without free)))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/02/06 19:25
-	10	(etch\$3 with (low adj k low-k BCB SiLk) same (oxygen-free oxygen adj free ((O2 "O.sub.2" oxygen) near (without free)))) not (etch\$3 with (low adj k low-k BCB SiLk) with (oxygen-free oxygen adj free ((O2 "O.sub.2" oxygen) near (without free))))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/02/06 19:25
-	6	etch\$3 same (low adj k low-k BCB SiLk) same (oxygen-free oxygen adj free ((O2 "O.sub.2" oxygen) near (without free))) not (etch\$3 with (low adj k low-k BCB SiLk) same (oxygen-free oxygen adj free ((O2 "O.sub.2" oxygen) near (without free))))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/02/06 20:08
-	81	etch\$3 same (low adj k low-k BCB SiLk) and (oxygen-free oxygen adj free ((O2 "O.sub.2" oxygen) near (without free))) not (etch\$3 with (low adj k low-k BCB SiLk) same (oxygen-free oxygen adj free ((O2 "O.sub.2" oxygen) near (without free))))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/02/06 20:09
-	2	etch\$3 same (low adj k low-k BCB SiLk) with (oxygen-free oxygen adj free ((O2 "O.sub.2" oxygen) near (without free))) not (etch\$3 with (low adj k low-k BCB SiLk) same (oxygen-free oxygen adj free ((O2 "O.sub.2" oxygen) near (without free))))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/02/06 20:09
-	36	etch\$3 near (low adj k low-k BCB SiLk) and (oxygen-free oxygen adj free ((O2 "O.sub.2" oxygen) near (without free)))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/02/06 20:11

	24	(etch\$3 near (low adj k low-k BCB SiLk) and (oxygen-free oxygen adj free ((O2 "O.sub.2" oxygen) near (without free)))) not ((etch\$3 with (low adj k low-k BCB SiLk) same (oxygen-free oxygen adj free ((O2 "O.sub.2" oxygen) near (without free)))) (etch\$3 with (low adj k low-k BCB SiLk) with (oxygen-free oxygen adj free ((O2 "O.sub.2" oxygen) near (without free)))) ((etch\$3 with (low adj k low-k BCB SiLk) same (oxygen-free oxygen adj free ((O2 "O.sub.2" oxygen) near (without free)))) not (etch\$3 with (low adj k low-k BCB SiLk) with (oxygen-free oxygen adj free ((O2 "O.sub.2" oxygen) near (without free)))) (etch\$3 same (low adj k low-k BCB SiLk) same (oxygen-free oxygen adj free ((O2 "O.sub.2" oxygen) near (without free)))) not (etch\$3 with (low adj k low-k BCB SiLk) same (oxygen-free oxygen adj free ((O2 "O.sub.2" oxygen) near (without free)))) (etch\$3 same (low adj k low-k BCB SiLk) with (oxygen-free oxygen adj free ((O2 "O.sub.2" oxygen) near (without free)))) not (etch\$3 with (low adj k low-k BCB SiLk) same (oxygen-free oxygen adj free ((O2 "O.sub.2" oxygen) near (without free))))))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/02/06 20:40
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	<p>24 (etch\$3 with (low adj k low-k BCB SiLk) and (oxygen-free oxygen adj free ((O2 "O.sub.2" oxygen) near (without free)))) not ((etch\$3 with (low adj k low-k BCB SiLk) same (oxygen-free oxygen adj free ((O2 "O.sub.2" oxygen) near (without free)))) (etch\$3 with (low adj k low-k BCB SiLk) with (oxygen-free oxygen adj free ((O2 "O.sub.2" oxygen) near (without free)))) ((etch\$3 with (low adj k low-k BCB SiLk) same (oxygen-free oxygen adj free ((O2 "O.sub.2" oxygen) near (without free)))) not (etch\$3 with (low adj k low-k BCB SiLk) with (oxygen-free oxygen adj free ((O2 "O.sub.2" oxygen) near (without free)))) (etch\$3 same (low adj k low-k BCB SiLk) same (oxygen-free oxygen adj free ((O2 "O.sub.2" oxygen) near (without free)))) not (etch\$3 with (low adj k low-k BCB SiLk) same (oxygen-free oxygen adj free ((O2 "O.sub.2" oxygen) near (without free)))) (etch\$3 same (low adj k low-k BCB SiLk) with (oxygen-free oxygen adj free ((O2 "O.sub.2" oxygen) near (without free)))) not (etch\$3 with (low adj k low-k BCB SiLk) same (oxygen-free oxygen adj free ((O2 "O.sub.2" oxygen) near (without free)))) (etch\$3 near (low adj k low-k BCB SiLk) and (oxygen-free oxygen adj free ((O2 "O.sub.2" oxygen) near (without free)))) ((etch\$3 near (low adj k low-k BCB SiLk) and (oxygen-free oxygen adj free ((O2 "O.sub.2" oxygen) near (without free)))) not ((etch\$3 with (low adj k low-k BCB SiLk) same (oxygen-free oxygen adj free ((O2 "O.sub.2" oxygen) near (without free)))) (etch\$3 with (low adj k low-k BCB SiLk) with (oxygen-free oxygen adj free ((O2 "O.sub.2" oxygen) near (without free)))) ((etch\$3 with (low adj k low-k BCB SiLk) same (oxygen-free oxygen adj free ((O2 "O.sub.2" oxygen) near (without free)))) not (etch\$3 with (low adj k low-k BCB SiLk) with (oxygen-free oxygen adj free ((O2 "O.sub.2" oxygen) near (without free)))) (etch\$3 same (low adj k low-k BCB SiLk) same (oxygen-free oxygen adj free ((O2 "O.sub.2" oxygen) near (without free)))) not (etch\$3 with (low adj k low-k BCB SiLk) same (oxygen-free oxygen adj free ((O2 "O.sub.2" oxygen) near (without free)))) (etch\$3 same (low adj k low-k BCB SiLk) with (oxygen-free oxygen adj free ((O2 "O.sub.2" oxygen) near (without free)))) not (etch\$3 with (low adj k low-k BCB SiLk) same (oxygen-free oxygen adj free ((O2 "O.sub.2" oxygen) near (without free))))))</p>	<p>USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB</p>	<p>2004/02/06 20:54</p>
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[illegible]

-	12	(low adj k low-k low adj dielectric) and (etch\$3 plasma) and ((nitrogen N2 "N.sub.2") same (C4F8 "C.sub.4 F.sub.8") same ("CF.sub.2 H.sub.2" "CH.sub.2 F.sub.2" CF2H2 CH2F2))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/02/17 15:18
-	13	(low adj k low-k low adj dielectric) and (etch\$3 plasma) and ((nitrogen N2 "N.sub.2") same (C5F8 "C.sub.5 F.sub.8") same (Ar argon))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/02/17 13:55
-	23	high adj density with MORI	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/02/17 15:09
-	15	<div> <div>"4512868"</div> <div>"4609428"</div> <div>"4859303"</div> <div>"4971653"</div> <div>"4985109"</div> <div>"4985112"</div> <div>"4990229"</div> <div>"5024748"</div> <div>"5091049"</div> <div>"5114529"</div> <div>"5122251"</div> <div>"5242536"</div> <div>"5336366"</div> <div>"5385624"</div> <div>"5449433"</div> </div> .PN.	USPAT	2004/02/17 15:12